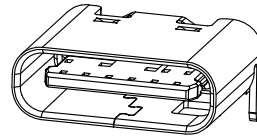
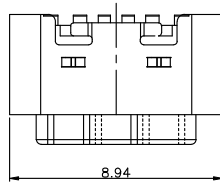


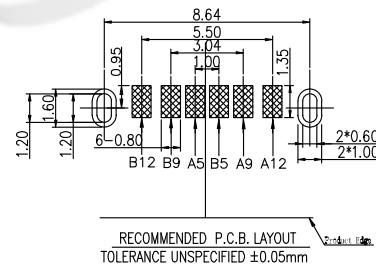
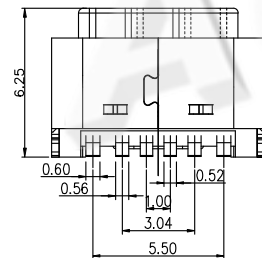
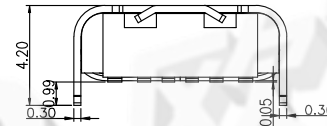
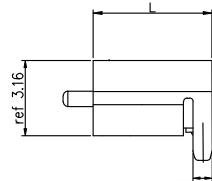
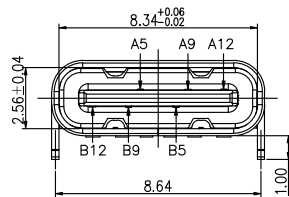
Rohs

REV.	DESCRIPTION	DRAW.	DATE.



NOTE:

- 1.MATERIAL SPECIFICATION:
 - 1.HOUSING:HIGH TEMPERATURE RESISTANT PLASTIC,UL94 V-0.
 - 2.CONTACTS:COPPER ALLOY
 - 3.MID PLATE: STAINLESS STEEL
 - 4.FRONT SHELL: STAINLESS STEEL
- 2.PLATING SPECIFICATION:
 - 2-1.CONTACTS:
 - Ni 50u" MIN. UNDER PLATED OVER ALL.
 - Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
 - (GOLD PLATING THICKNESS FOLLOW THE P/N)
 - PLATING SPECIFICATIONS OF THE SOLDER AREA FOLLOW THE P/N
 - 2-2.FRONT SHELL:
 - SEE TABLE1.
 - 2-3.SHIELD PLATE&EMI PLATE:
 - CLEAR ONLY
- 3.MECHANICAL PERFORMANCE,
 - 3-1.INSERTION FORCE: 0.5~2.0kgf.
 - 3-2.REMOVAL FORCE: 0.8kgf~2.0kgf.
 - 3-3.DURABILITY: 3000 CYCLES.
- 4.ELECTRICAL PERFORMANCE,
 - 4-1. CURRENT RATING:3.0A
 - VOLTAGE RATING:5.0V
 - 4-2. LLCR:
 - VBUS & GND PINS AND OTHER PINS: 40mΩ/PIN MAX.
 - SHIELD: 50mΩ/MAX.
 - LLCR MAX. CHANGE OF ALL PINS: 10mΩ.
 - 4-3.INSULATION RESISTANCE: 100MΩ MIN
 - 4-4.DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.
5. ENVIRONMENTAL PERFORMANCE:
 - OPERATING TEMPERATURE: -25°C~+85°C.
- 6.IR REFLOW:
 - THE PEAK TEMPERATURE ON THE BOARD SHALL BE MAINTAINED FOR 5 SECONDS AT 260°C.



PIN ASSIGNMENTS

A5	CC1	B12	GND		
A9	VBUS	B9	VBUS		
A12	GND	B5	CC2	L	L = 5.5
PIN	SIGNAL NAME	PIN	SIGNAL NAME	L	L = 5.0

AUGO

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REV:	01
SIZE:	A4
SCALE:1:1	UNIT:mm
SHEET:1/1	

UNLESS OTHERWISE SPECIFIED,TOLERANCE:	
X.	±0.20
X.x	±0.15
X.xx	±0.10
ANGULAR	±2°

TITLE:	TYPE-C SERIES
PART NO	TYPE-C 6PIN 贴片SMD L5.0/5.5

DESIGN	H.Y.ZHU	DATE	
DRAWING	W.B.QIAO	DATE	
CHECK	G.C.CHEN	DATE	
SCALE	1:1	PAGE	1 OF 1